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### **General Description**

The MAX4704 low-voltage, 4-channel analog multiplexer operates from a single +1.8V to +5.5V supply. The MAX4704 features break-before-make switching action with a  $t_{ON} = 60$ ns and  $t_{OFF} = 20$ ns at +3V.

When powered from a +2.7V supply, the device has a  $60\Omega$  (max) on-resistance (RoN), with  $3\Omega$  (max) RoN matching and  $5\Omega$  max R<sub>ON</sub> flatness. The digital logic inputs are 1.8V-logic compatible from a +2.7V to +3.3V supply. The MAX4704 is available in both a space-saving 12-pin QFN (3mm x 3mm) package and a 10-pin µMAX package.

### **Applications**

MP3 Players

Battery-Operated Equipment

Relay Replacement

Audio and Video Signal Routing

Low-Voltage Data-Acquisition Systems

Communications Circuits

**PCMCIA Cards** 

Cellular Phones

Modems

### **Features**

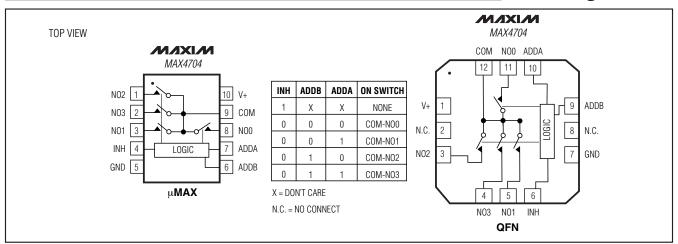
- ♦ 3mm x 3mm 12-Pin QFN Package
- ♦ Guaranteed On-Resistance: 60 $\Omega$  (max) (+2.7V Supply)  $40\Omega$  (max) (+5V Supply)
- ♦ Guaranteed Match Between Channels: 3Ω (max)
- **♦** Guaranteed Flatness Over Signal Range:  $5\Omega$  (max)
- **♦** Guaranteed Low Leakage Currents: 100pA (max) at +25°C
- ♦ Switching Time: toN = 60ns, toFF = 20ns
- ♦ +1.8V to +5.5V Single-Supply Operation
- ♦ Rail-to-Rail Signal Handling
- ♦ -3dB Bandwidth: >200MHz
- ♦ Low Crosstalk: -90dB (1MHz)
- ♦ High Off-Isolation: -85dB (1MHz)
- ♦ Low 3pC Charge Injection
- ♦ THD: 0.02%
- ♦ +1.8V CMOS-Logic Compatible

### **Ordering Information**

PART	TEMP. RANGE	PIN-PACKAGE
MAX4704EGC	-40°C to +85°C	12 QFN-EP*
MAX4704EUB	-40°C to +85°C	10 μMAX

<sup>\*</sup>EP = Exposed Pad

### **Pin Configurations**



### **ABSOLUTE MAXIMUM RATINGS**

(Voltages Referenced to GND)	
V+	0.3V to +6V
All Other Pins (Note 1)	0.3V  to  (V++0.3V)
Continuous Current COM, NO	±20mA
Peak Current COM, NO_	
(pulsed at 1ms, 10% duty cycle)	±40mA
ESD per Method 3015.7	>2kV

Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )	
10-Pin µMAX (derate 4.7mW/°C above +70°	C) 330mW
12-Pin QFN (derate 11.9mW/°C above +70°	C) 952mW
Operating Temperature Range	40°C to +85°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C

**Note 1:** Signals on INH, ADD\_, NO\_, and COM exceeding V+ or GND are clamped by internal diodes. Limit forward-diode current to maximum current rating.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS—Single +3V Supply**

 $(V+=+2.7V \text{ to } +3.3V, V_{IH}=+1.4V, V_{IL}=+0.5V, T_A=-40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$  Typical values are at V+=+3V and  $T_A=+25^{\circ}\text{C}$ .) (Notes 2, 3)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP	MAX	UNITS
ANALOG SWITCH	•						
Analog Signal Range	V <sub>COM</sub> , V <sub>NO</sub> _			0		V+	V
O- D	р.	V+ = +2.7V, I <sub>COM</sub> = 5mA,	+25°C		50	60	
On-Resistance	Ron	$V_{NO} = +1.3V$	T <sub>MIN</sub> to T <sub>MAX</sub>			70	Ω
On-Resistance Match	ΔR <sub>ON</sub>	$V+ = +2.7V$ , $I_{COM} = 5mA$ ,	+25°C		1	3	Ω
Between Channels (Note 4)	ΔhON	$V_{NO_{-}} = +1.3V$	T <sub>MIN</sub> to T <sub>MAX</sub>			5	52
On-Resistance Flatness	RFLAT (ON)	$V+ = +2.7V$ , $I_{COM} = 5mA$ ,	+25°C		3	5	Ω
(Note 5)	TIFLAT (ON)	$V_{NO_{-}} = +1V, +1.3V, +1.8V$	$T_{\mbox{\scriptsize MIN}}$ to $T_{\mbox{\scriptsize MAX}}$			10	52
NO_ Off-Leakage	INO (OFF)	$V + = +3.3V, V_{COM} = +0.3V, +3V$	+25°C	-0.1	±0.01	0.1	nA
Current (Note 6)	INO_(OFF)	$V_{NO_{-}} = +3V, +0.3V$	T <sub>MIN</sub> to T <sub>MAX</sub>	-1		1	шА
COM On-Leakage Current	ICOM(ON)	ICOM(ON)	+25°C	-0.5	±0.01	0.5	·- A
(Note 6)			T <sub>MIN</sub> to T <sub>MAX</sub>	-5		5	nA
COM Off-Leakage Current	1	$V_{NO} = +3.3V, V_{COM} = +0.3V, +3V$ $V_{NO} = +3V, +0.3V$	+25°C	-0.5	±0.01	0.5	nA
(Note 6)	ICOM(OFF)		T <sub>MIN</sub> to T <sub>MAX</sub>	-5		5	
DYNAMIC							
Address Transition Time	t	$V_{NO}$ = +1.5V, $R_L$ = 300 $\Omega$ , $C_L$ = 35pF, Figure 2	+25°C		20	60	200
Address Transition Time	trans		T <sub>MIN</sub> to T <sub>MAX</sub>			70	ns
Inhibit Turn-On Time	tou	$V_{NO} = +1.5V, R_L = 300\Omega,$	+25°C		25	60	200
innibit rum-On time	ton	C <sub>L</sub> = 35pF, Figure 3	T <sub>MIN</sub> to T <sub>MAX</sub>			70	ns
Inhibit Turn-Off Time	torr	$V_{NO} = +1.5V, R_{L} = 300\Omega,$	+25°C		10	20	no
Initibili Turn-Ott Time top	tOFF	C <sub>L</sub> = 35pF, Figure 3	T <sub>MIN</sub> to T <sub>MAX</sub>			30	ns
Break-Before-Make Time	fore-Make Time $ \begin{array}{c} \text{V}_{NO\_} = +1.5 \text{V},  \text{R}_{L} = 300 \Omega, \\ \text{C}_{L} = 35 \text{pF},  \text{Figure 4} \end{array} $	$V_{NO} = +1.5V, R_L = 300\Omega,$	+25°C		20		ns
(Note 7)		C <sub>L</sub> = 35pF, Figure 4	$T_{\mbox{\scriptsize MIN}}$ to $T_{\mbox{\scriptsize MAX}}$	2			115
Charge Injection	Q	V <sub>GEN</sub> = 0, R <sub>GEN</sub> = 0, C <sub>L</sub> = 1.0nF, Figure 5			2		рС

### **ELECTRICAL CHARACTERISTICS—Single +3V Supply (continued)**

 $(V+=+2.7V \text{ to } +3.3V, V_{IH}=+1.4V, V_{IL}=+0.5V, T_A=-40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$  Typical values are at V+=+3V and  $T_A=+25^{\circ}\text{C}$ .) (Notes 2, 3)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP I	MAX	UNITS
On-Channel -3dB Bandwidth	BW	Signal = 0dBm, $50\Omega$ in and out, Figure 6		>	>200		MHz
Off-Isolation (Note 8)	V <sub>ISO</sub>	$f = 1MHz$ , $R_L = 50\Omega$ , $C_L = 5pF$ , Figure 6			-85		dB
Crosstalk (Note 9)	VCT	$f = 1MHz$ , $R_L = 50\Omega$ , $C_L = 5pF$ , Figure 6			-90		dB
NO_ Off-Capacitance	C <sub>NO_(OFF)</sub>	f = 1MHz, V <sub>NO</sub> = GND, Figure 7			7		pF
COM On-Capacitance	CCOM(ON)	f = 1MHz, V <sub>NO</sub> = GND, Figure 7			19		pF
COM Off-Capacitance	CCOM(OFF)	f = 1MHz, V <sub>NO</sub> = GND, Figure 7			15		pF
DIGITAL I/O							
Input Logic High	VIH			1.4			V
Input Logic Low	VIL					0.5	V
Input Leakage Current	I <sub>IH</sub> , I <sub>IL</sub>	ADD_, INH = 0 or V+		-1		1	μA
SUPPLY							
Power-Supply Range	V+			1.8		5.5	V
Power-Supply Current	l+	V+ = +5.5V, ADD_, INH = 0 or V+				1	μΑ

### **ELECTRICAL CHARACTERISTICS—Single +5V Supply**

 $(V+=+4.5V \text{ to } +5.5V, V_{IH}=+2.0V, V_{IL}=+0.8V, T_A=-40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$  Typical values are at V+=+5V and  $T_A=+25^{\circ}\text{C}.)$  (Notes 2, 3)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP	MAX	UNITS
ANALOG SWITCH							
Analog Signal Range	V <sub>COM</sub> , V <sub>NO</sub> _			0		V+	V
On Desistance	Davi	$V + = +4.5V$ , $I_{COM} = 5mA$ ,	+25°C		30	40	
On-Resistance	Ron	$V_{NO} = +3.5V$	T <sub>MIN</sub> to T <sub>MAX</sub>			50	Ω
On-Resistance Match	ΔRON	$V_{NO} = +4.5V, I_{COM} = 5mA, V_{NO} = +3.5V$	+25°C		1	2	Ω
Between Channels (Note 4)	ΔηΟΝ		T <sub>MIN</sub> to T <sub>MAX</sub>			3	52
On-Resistance Flatness	De. 17 (01)	RELATION)	+25°C		3	5	Ω
(Note 5)	THLAT (ON)		T <sub>MIN</sub> to T <sub>MAX</sub>			10	52
NO_ Off-Leakage	luc (off)	$V + = +5.5V, V_{COM} = +0.5V, +5V$	+25°C	-0.1	±0.01	0.1	, n
Current (Note 6)	INO_(OFF)	$V_{NO} = +5V, +0.5V$	T <sub>MIN</sub> to T <sub>MAX</sub>	-1		1	nA
COM On-Leakage Current	le et wet n	$V + = +5.5V, V_{COM} = +0.5V, +5V$	+25°C	-0.5	±0.01	0.5	nA
(Note 6)	ICOM(ON)	ICOM(ON) Ly	T <sub>MIN</sub> to T <sub>MAX</sub>	-5		5	] IIA

### **ELECTRICAL CHARACTERISTICS—Single +5V Supply (continued)**

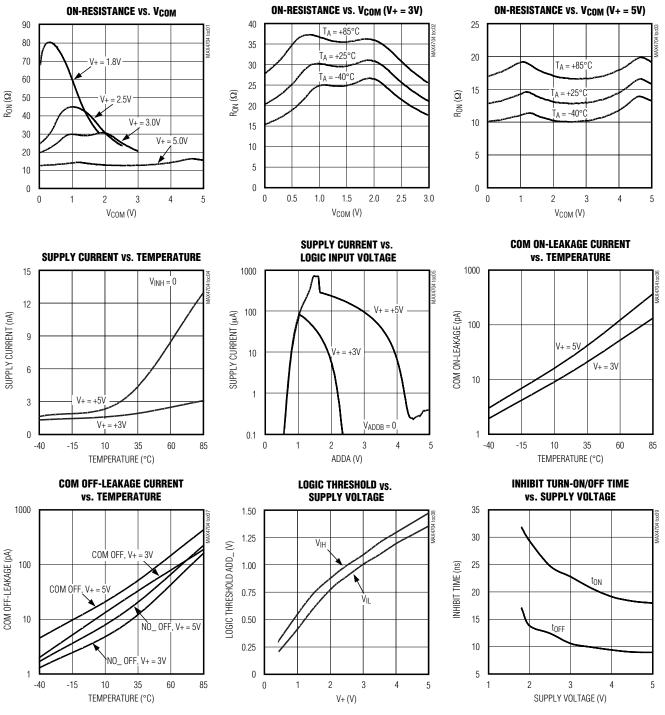
 $(V+=+4.5V \text{ to } +5.5V, V_{IH}=+2.0V, V_{IL}=+0.8V, T_A=-40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$  Typical values are at V+=+5V and  $T_A=+25^{\circ}\text{C}.)$  (Notes 2, 3)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP	MAX	UNITS
COM Off-Leakage Current	ICOM(OFF)	$V + = +5.5V, V_{COM} = +0.5V, +5V$	+25°C	-0.5	±0.01	0.5	nA
COM On-Leakage Current		$V_{NO} = +5V, +0.5V$	T <sub>MIN</sub> to T <sub>MAX</sub>	-5		5	IIA
DYNAMIC							
Address Transition Time	tTDANO.	$V_{NO} = +3V, R_L = 300\Omega,$	+25°C		15	35	ns
Address Transition Time	t <sub>TRANS</sub>	C <sub>L</sub> = 35pF, Figure 2	T <sub>MIN</sub> to T <sub>MAX</sub>			40	115
Inhibit Turn-On Time	ton	$V_{NO} = +3V, R_L = 300\Omega,$	+25°C		18	35	ns
ITITIDIL TUTTI OTI TITIC	TON	C <sub>L</sub> = 35pF, Figure 3	$T_{\mbox{\scriptsize MIN}}$ to $T_{\mbox{\scriptsize MAX}}$			40	110
Inhibit Turn-Off Time	toff	$V_{NO} = +3V, R_L = 300\Omega,$	+25°C		9	20	ns
	UFF	C <sub>L</sub> = 35pF, Figure 3	T <sub>MIN</sub> to T <sub>MAX</sub>			30	110
Break-Before-Make Time	tBBM	$V_{NO} = +3V, R_L = 300\Omega,$	+25°C		20		ns
(Note 7)	rBBINI	C <sub>L</sub> = 35pF, Figure 4	T <sub>MIN</sub> to T <sub>MAX</sub>	2			113
Charge Injection	Q	$V_{GEN} = 0$ , $R_{GEN} = 0$ , $C_L = 1.0$ nF, Figure 5			3		рС
On-Channel -3dB Bandwidth	BW	Signal = 0dBm, $50\Omega$ in and out, Figure 6			>200		MHz
Off-Isolation (Note 8)	V <sub>ISO</sub>	$f = 1MHz$ , $R_L = 50\Omega$ , $C_L = 5pF$ , Figure 6			-85		dB
Crosstalk (Note 9)	VcT	$f = 1MHz$ , $R_L = 50\Omega$ , $C_L = 5pF$ , Figure 6			-90		dB
Total Harmonic Distortion	THD	$f = 20Hz$ to $20kHz$ , $1Vp-p$ , $R_L = 600\Omega$			0.02		%
DIGITAL I/O							
Input Logic High	VIH			2.0			V
Input Logic Low	V <sub>I</sub> L					0.8	V
Input Leakage Current	I <sub>IH</sub> , I <sub>IL</sub>	ADD_, INH = 0 or V+		-1		1	μΑ
SUPPLY							
Power-Supply Range	V+			1.8		5.5	V
Positive Supply Current	l+	V+ = +5.5V, ADD_, INH = 0 or V+				1	μΑ

- Note 2: The algebraic convention, where the most negative value is a minimum and the most positive value a maximum, is used in this data sheet.
- **Note 3:** -40°C specifications are guaranteed by design.
- **Note 4:**  $\Delta R_{ON} = R_{ON(MAX)} R_{ON(MIN)}$ .
- **Note 5:** Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.
- **Note 6:** Leakage currents are 100% tested at  $T_A = +85$ °C. Limits across the full temperature range are guaranteed by correlation.
- Note 7: Guaranteed by design.
- Note 8: Off-Isolation =  $20log_{10}$  ( $V_{COM} / V_{NO}$ ),  $V_{COM}$  = output,  $V_{NO}$  = input to off switch.
- Note 9: Between any two switches.

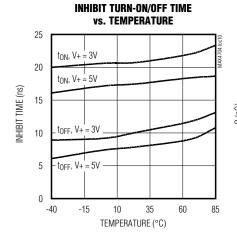
### **Typical Operating Characteristics**

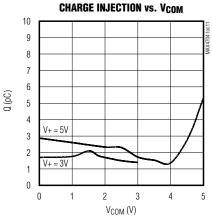
 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$ 

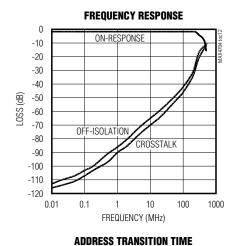


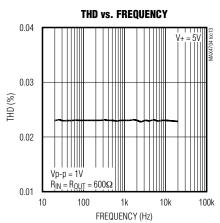
### Typical Operating Characteristics (continued)

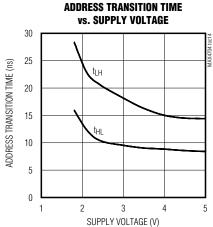
 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$ 

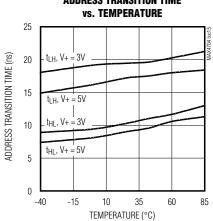












### **Pin Description**

Р	PIN	NAME	FUNCTION
μMAX	QFN-EP	NAME	FUNCTION
10	1	V+	Positive Supply Voltage
_	2, 8	N.C.	No Connection. Not internally connected.
1	3	NO2	Analog Switch 2. Normally open.
2	4	NO3	Analog Switch 3. Normally open.
3	5	NO1	Analog Switch 1. Normally open.
4	6	INH	Inhibit. Connect to GND for normal operation. Connect to logic-level high to turn all switches off.
5	7	GND	Ground
6	9	ADDB	Address Decoder Selection B
7	10	ADDA	Address Decoder Selection A
8	11	NO0	Analog Switch 0. Normally open.
9	12	COM	Analog Switch Common Terminal
_	_	EP	Exposed Pad. Internally connected to GND. Connect to a large ground plane to maximize thermal performance; not intended as an electrical connection point (QFN package only).

### **Detailed Description**

The MAX4704 low-voltage, 4-channel analog multiplexer operates from a single +1.8V to +5.5V supply. When powered from a +2.7V supply, the device has a  $60\Omega$  (max) on-resistance (RoN), with  $3\Omega$  (max) RoN matching and  $5\Omega$  (max) RoN flatness. The digital logic inputs are +1.8V-logic compatible from a +2.7V to +3.3V supply.

### **Applications Information**

### **Digital Control Inputs**

The MAX4704 logic inputs are +1.8V CMOS logic compatible for 3V operation and TTL compatible for 5V operation of V+. Driving ADD\_rail-to-rail minimizes power consumption.

### **Analog Signal Levels**

Analog signals that range over the entire supply voltage (V+ to GND) are passed with very little change in on-resistance (see *Typical Operating Characteristics*). The switches are bidirectional, so the NO\_ and COM pins can be either inputs or outputs.

### Power-Supply Sequencing and Overvoltage Protection

Caution: Do not exceed the absolute maximum ratings because stresses beyond those listed may cause permanent damage to devices.

Proper power-supply sequencing is recommended for all CMOS devices. Always apply V+ before applying analog signals, especially if the analog signal is not current limited. If this sequencing is not possible, and if the analog inputs are not current limited to <20mA, add a small-signal diode

(D1) as shown in Figure 1. If the analog signal can dip below GND, add D2. Adding protection diodes reduces the analog range to a diode drop (about 0.7V) below V+ (for D1), and a diode drop above ground (for D2). On-resistance increases slightly at low supply voltages. Maximum supply voltage (V+) must not exceed +6V.

Adding protection diode D2 causes the logic threshold to be shifted relative to GND. TTL compatibility is not guaranteed when D2 is added.

Protection diodes D1 and D2 also protect against some overvoltage situations. In the circuit in Figure 1, if the supply voltage is below the absolute maximum rating, and if a fault voltage up to the absolute maximum rating is applied to an analog signal pin, no damage will result.

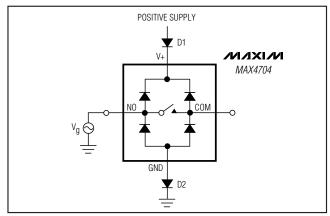


Figure 1. Overvoltage Protection Using Two External Blocking Diodes

### **Test Circuits/Timing Diagrams**

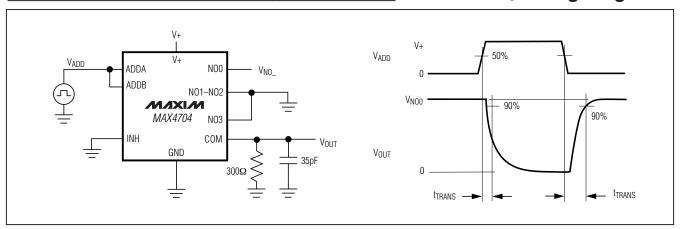


Figure 2. Address Transition Time

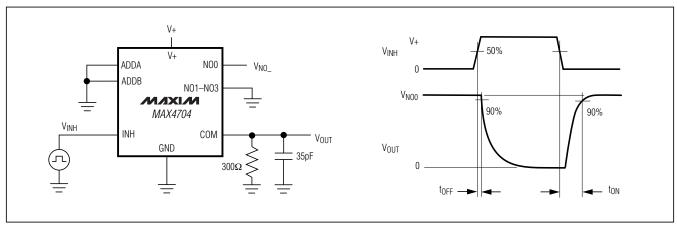


Figure 3. Inhibit Switching Times

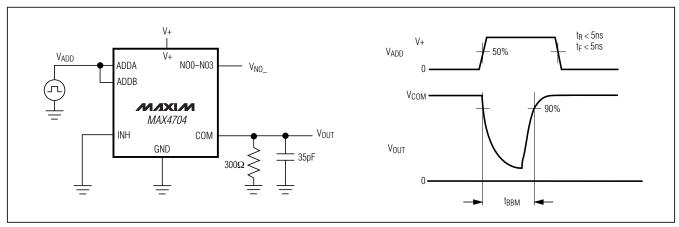


Figure 4. Break-Before-Make Interval

### Test Circuits/Timing Diagrams (continued)

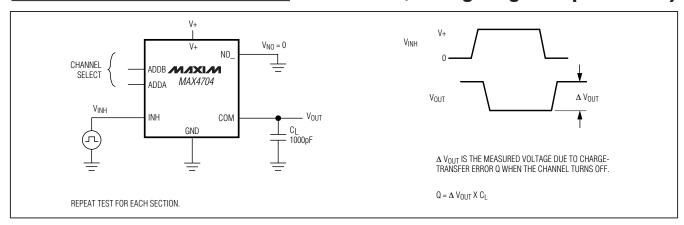


Figure 5. Charge Injection

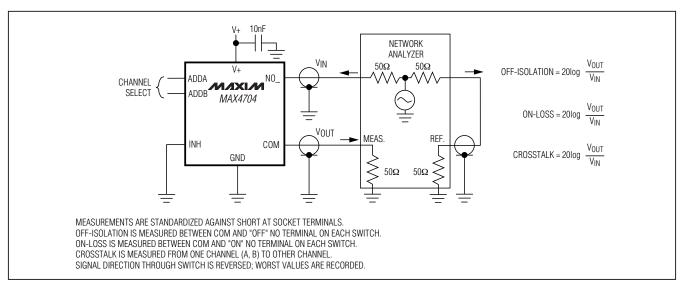


Figure 6. Off-Isolation, On-Loss, and Crosstalk

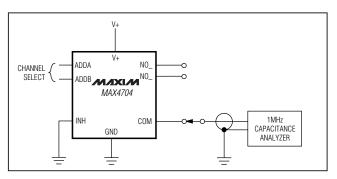


Figure 7. NO\_/COM Capacitance

### **Chip Information**

TRANSISTOR COUNT: 256

PROCESS: CMOS

## **Package Information**

For the latest package outline information and land patterns, go to <a href="www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
12 QFN-EP	G1233-1	<u>21-0102</u>
10 μMAX	_	<u>21-0061</u>

### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	10/01	Initial release	
1	10/08	Inserted exposed paddle description	1, 7

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